TOSHIBA LED Lamp InGaAlP Red Light Emission

TLRE157AP

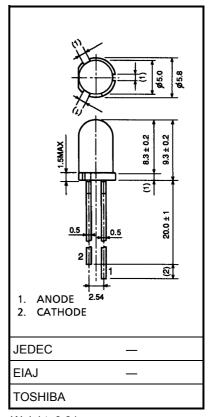
Panel Circuit Indicator

Unit in mm

- 5mm diameter (T1-3 / 4)
- InGaAlP red LED
- All plastic mold type.
- Colorless clear lens
- Low drive current, high intensity red light emission Recommended forward current: $I_f = 15 \sim 20 \text{mA}$ (DC)
- All plastic molded lens, provides an excellent on-off contrast ratio.
- Fast response time, capable of pulse operation.
- · High power luminous intensity
- Without stand-offs
- Applications: Suitable for outdoor message signboard, safety equipment. automotive use.

Maximum Ratings (Ta = 25°C)

Characteristic	Symbol	Rating	Unit	
Forward current (DC)	l _F	50	mA	
Reverse voltage	V _R	4	V	
Power dissipation	P _D	125	mW	
Operating temperature range	T _{opr}	-30~85	°C	
Storage temperature range	T _{stg}	-40~120	°C	



Weight: 0.31g

Electrical And Optical Characteristics (Ta = 25°C)

Characteristic		Symbol	Test Condition			Min	Тур.	Max	Unit
Forward voltage		V _F	I _F =20mA			_	1.85	2.4	V
Reverse current		I _R	V _R =4V			-	_	50	μА
Luminous intensity	TLRE157AP	- I _V	I _F =20mA	(Ne	ote) -	272	1000	_	mcd
	TLRE157AP(ST)			(140	ole) -	850	_	4140	
Peak emission wavelength		λρ	I _F =20mA			_	644	_	nm
Spectral line half width		Δλ	I _F =20mA			_	18	_	nm
Dominant wavelength		λd	I _F =20mA			_	630	1	nm

(Note): Lamps are classified into the following ranks according to their luminous intensity.

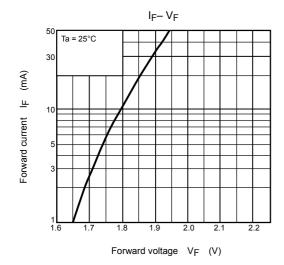
Mesurement tolerance for each limit is ±15%.

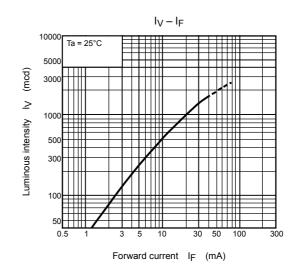
Q: 320-640mcd, R: 560-1120mcd, S: 1000-2000mcd, T: 1800-3600mcd, U: 3200-6400mcd

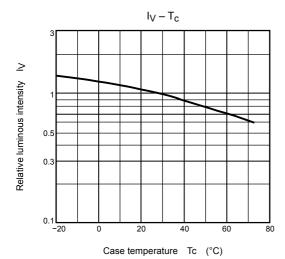
Precaution

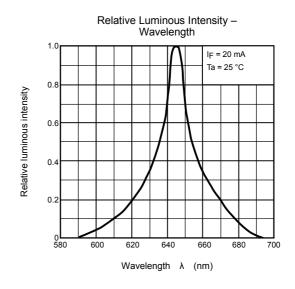
Please be careful of the followings

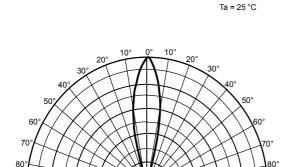
- Soldering temperature: 260°Cmax Soldering time: 3s max (Soldering portion of lead: Up to 2mm from the body of the device)
- If the lead is formed, the lead should be formed up to 5mm from the body of the device without forming stress to the resin. Soldering should be performed after lead forming.
- This visible LED lamp also emits some IR light. If a photodetector is located near the LED lamp, please ensure that it will not be affected by this IR light.





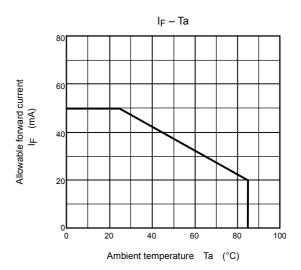






0.4

Radiation Pattern



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